



Dr Bob Wei-Ming Chen

Non-Independent Non-Executive Director

Dr. Chen Wei-Ming Chen was appointed as Non-Independent Non-Executive Director of Dagang NeXchange Berhad ("DNeX") on 22 June 2021.

History

He currently serves as Vice President and Head of Semiconductor Business Group of Hon Hai Technology Group ("Foxconn"). He began his career with Motorola's Advanced Product Research Laboratory doing power PCs and embedded memory research and development ("R&D") at Austin Texas in 1994. He joined TSMC in 1998 as R&D Manager and was then promoted to Deputy Director, in charge of the integration of several technology nodes and various technology flavors for more than ten years. He subsequently joined the management corporate advisory division of an international accounting firm and was involved with various corporate restructuring exercises.

In 2008, he joined TSMC's package subsidiary Xintec Inc. as R&D Vice President doing research in wafer level packages, pioneering TSV and 3DIC packages. From 2009 to 2011 he started his own company, MOS Art Packaging, to continue developing wafer level package products. He then joined Neo Solar Power ("NSP") in 2011 as Vice President of R&D and then was promoted to President of the Cell Business Unit. Through his leadership, NSP maintained the highest efficiency of p-type solar cell and module mass production and built three solar cell fabs in three different countries outside Taiwan. He also realised the mass production of Taiwan's first n-type heterojunction solar cell ("HJT").

He joined Hon Hai Technology Group as Vice President and special assistant to founder Terry Guo in 2017. He joined the Hon Hai Semiconductor Group in 2019. Since then, he has served on the board of Hon Hai Group's subsidiaries, including Sharp, Foxsemicon, Shun Sin Technology, and Socle Technology. He has established several semiconductor start-ups across fields from package to IC design within Hon Hai Technology Group. He has about 30 patents and 40 publications.

He received his M.S. and Ph.D. in Electrical Engineering specialised in microelectronics from University of Texas at Austin in 1990, and 1994 respectively. He has an EMBA degree from National Chiao-Tung University, Taiwan, and a B.S. degree in Materials Science from National Tsing-Hua University, Taiwan.